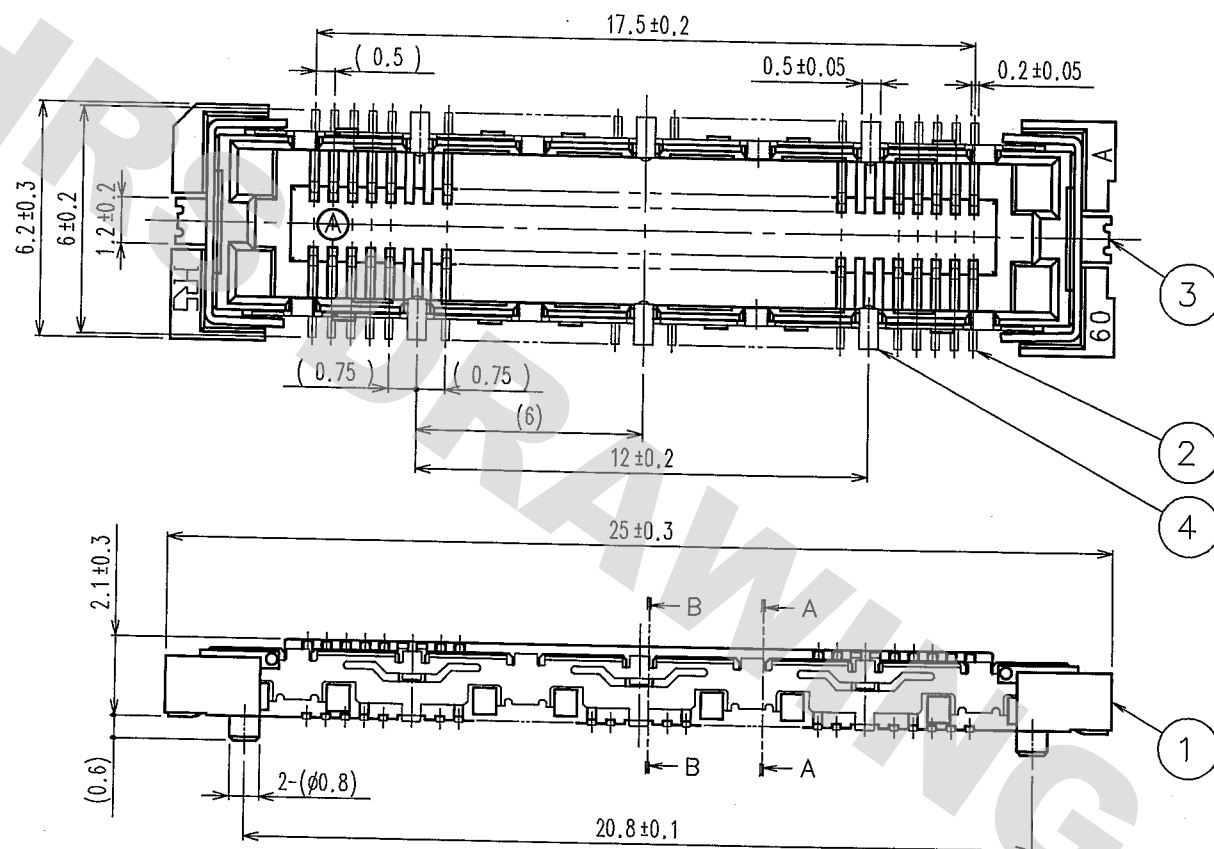
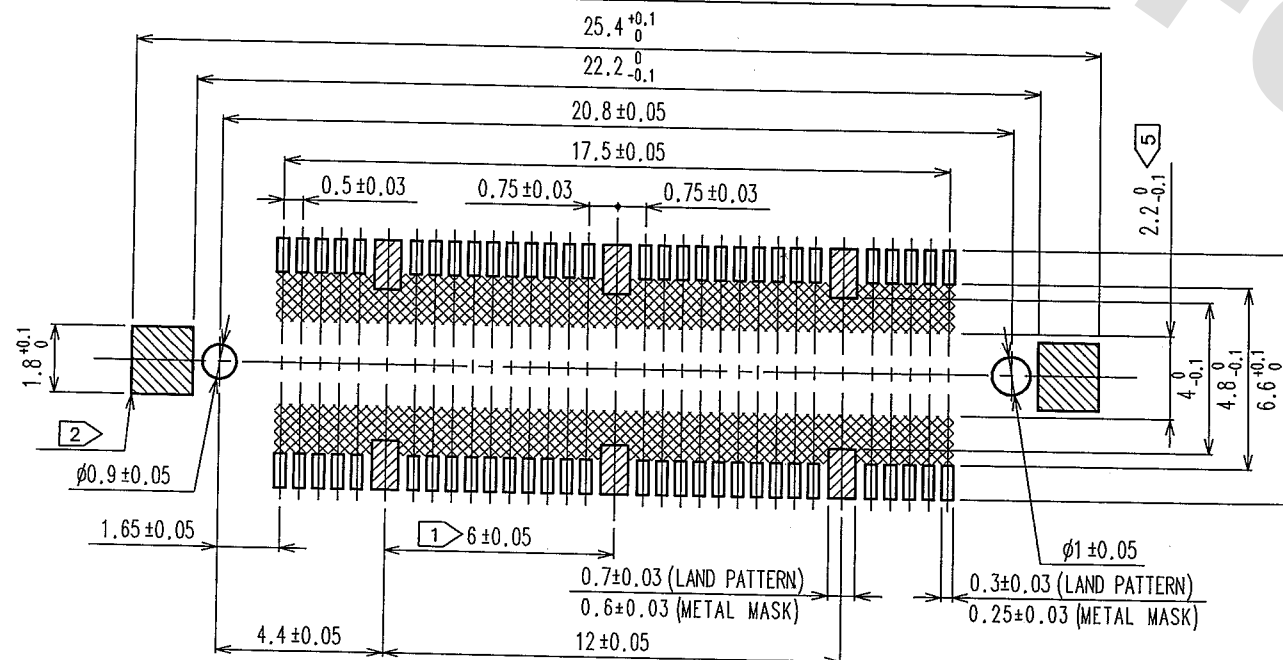


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

TO



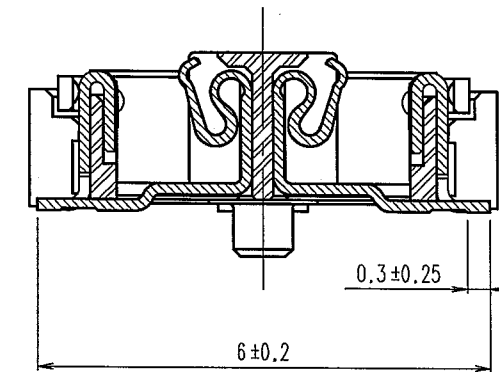
RECOMMENDED LAND PATTERN DIMENSION OF PCB



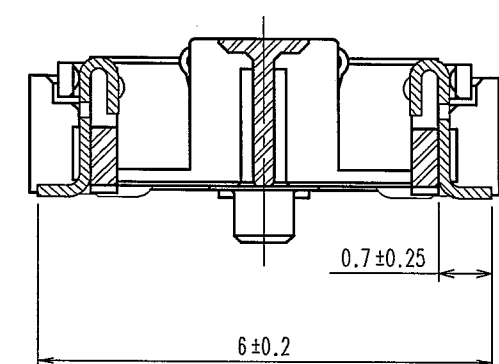
- NOTES
- ① 6 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ DIMENSION IN PARENTHESES ARE FOR REFERENCE.

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE

A-A (10:1)



B-B (10:1)



3,4	PHOSPHOR BRONZE	TIN PLATING	2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.
1	LCP	BEIGE UL94V-0			MOUNTING AREA : GOLD FLASH
					UNDER PLATING : NICKEL 1.0μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD) CL		DRAWN T.YANAGISAWA '05.10.12	DESIGNED T.Moda '05.10.13	CHECKED K.Ogawa '05.10.13	APPROVED K.Ogawa '05.10.13
SCALE 5 : 1 UNITS mm		DRAWING NO. EDC3-152632-25	PART NO. FX11A-60S/6-SV(71)	CODE NO. CL573-0702-9-71	
HRS HIROSE ELECTRIC CO., LTD.				1/1	